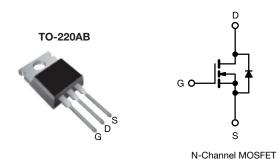
Vishay Siliconix

COMPLIANT

HALOGEN

FREE

E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
$R_{DS(on)}$ typ. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.043			
Q _g max. (nC)	130				
Q _{gs} (nC)	25				
Q _{gd} (nC)	19				

Single

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP050N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V_{DS}	600	V
Gate-source voltage			V_{GS}	± 30	
Continuous drain surrent (T. – 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	I _D	51	A
Continuous drain current (T _J = 150 °C)		T _C = 100 °C		32	
Pulsed drain current ^a			I _{DM}	155	
Linear derating factor				2.2	W/°C
Single pulse avalanche energy b			E _{AS}	427	mJ
Maximum power dissipation			P _D	278	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 ^{\circ}\text{C}$		dv/dt	70	V/ns	
Reverse diode dv/dt ^d			50		
Soldering recommendations (peak temperature) ^c	(peak temperature) ^c For 10 s			260	°C

Notes

- Initial samples marked as "SiHP50N60E"
- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5.5 A
- c. 1.6 mm from case

Configuration

d. $I_{SD} \le I_D$, di/dt = 100 A/ μ s, starting $T_J = 25$ °C



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W	
Maximum junction-to-case (drain)	R_{thJC}	-	0.45	C/VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.60	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3.0	-	5.0	V
Gate-source leakage	I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA
		,	V _{GS} = ± 30 V		-	± 1	μΑ
Zava gata valtaga dvain avvvant		V _{DS} =	600 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 23 A	-	0.043	0.050	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 20 V, I _D = 23 A	-	12	-	S
Dynamic							
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	3459	-	-
Output capacitance	C _{oss}	Ţ,	$V_{DS} = 100 \text{ V},$	-	148	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	7	-	_
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	114	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	706	-	
Total gate charge	Qg			-	65	130	
Gate-source charge	Q_{gs}	$V_{GS} = 10 \text{ V}$	$I_D = 23 \text{ A}, V_{DS} = 480 \text{ V}$	-	25	-	nC
Gate-drain charge	Q_{gd}			-	19	-	
Turn-on delay time	t _{d(on)}			-	35	70	
Rise time	t _r	$V_{DD} = 480 \text{ V}, I_D = 23 \text{ A},$		-	82	164	ns
Turn-off delay time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		67	134	
Fall time	t _f	1		-	48	96	
Gate input resistance	R_g	f = 1 MHz, open drain		0.43	0.85	1.72	Ω
Drain-Source Body Diode Characteristic	es						
Continuous source-drain diode current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	50	
Pulsed diode forward current	I _{SM}			-	-	155	- A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 23 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	-		-	435	870	ns
Reverse recovery charge	Q _{rr}		$5 ^{\circ}\text{C}, I_{\text{F}} = I_{\text{S}} = 23 \text{A},$	-	9.2	18.4	μC
Reverse recovery current	I _{RRM}	ai/at = 1	00 A/ μ s, V _R = 400 V	-	39	-	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

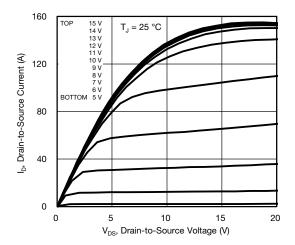


Fig. 1 - Typical Output Characteristics

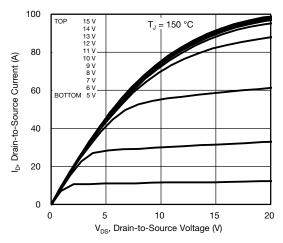


Fig. 2 - Typical Output Characteristics

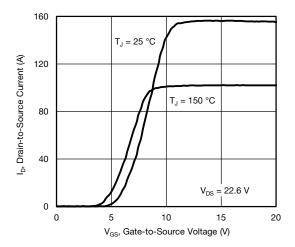


Fig. 3 - Typical Transfer Characteristics

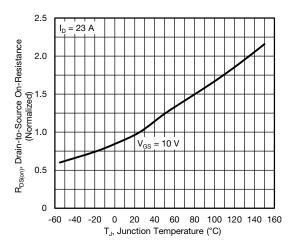


Fig. 4 - Normalized On-Resistance vs. Temperature

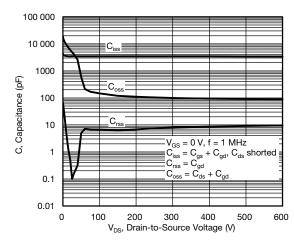


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

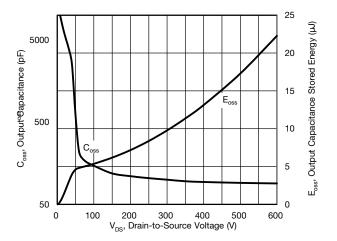


Fig. 6 - Coss and Eoss vs. VDS



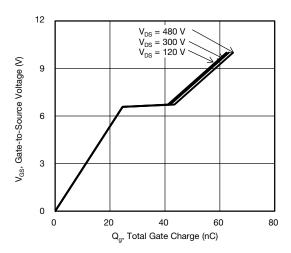


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

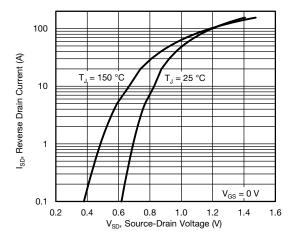


Fig. 8 - Typical Source-Drain Diode Forward Voltage

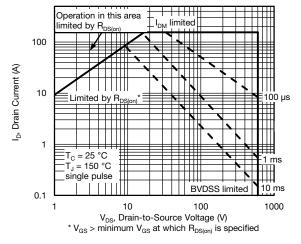


Fig. 9 - Maximum Safe Operating Area

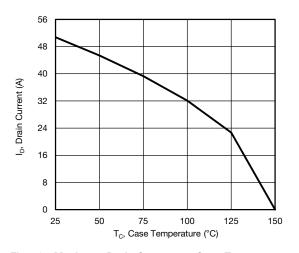


Fig. 10 - Maximum Drain Current vs. Case Temperature

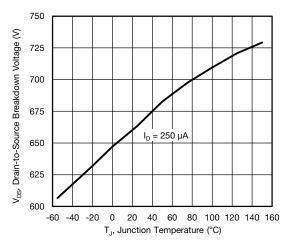


Fig. 11 - Temperature vs. Drain-to-Source Voltage



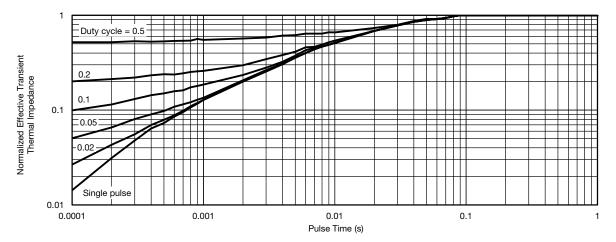


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

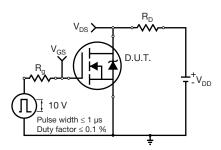


Fig. 13 - Switching Time Test Circuit

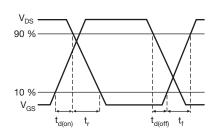


Fig. 14 - Switching Time Waveforms

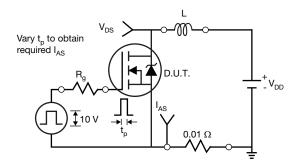


Fig. 15 - Unclamped Inductive Test Circuit

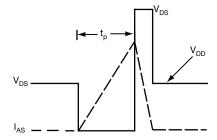


Fig. 16 - Unclamped Inductive Waveforms

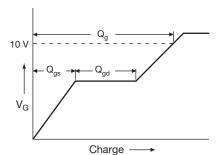


Fig. 17 - Basic Gate Charge Waveform

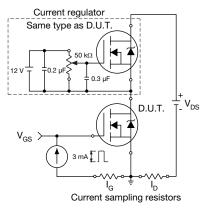
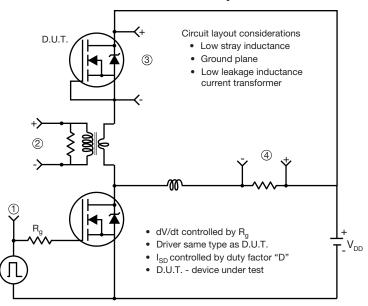


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



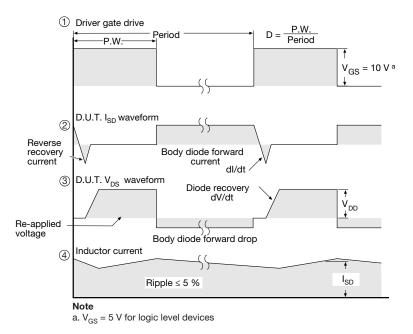
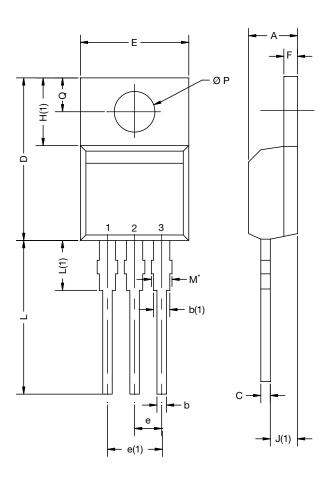


Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØΡ	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Revison: 04-Nov-2021 1 Document Number: 66542

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